TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

# TC7WT126FU

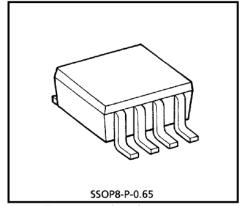
# **INVERTED, 3-STATE OUTPUT**

The TC7WT126FU is a high speed CMOS DUAL BUS BUFFERS fabricated with silicon gate CMOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The input threshold levels are compatible with TTL output voltage.

The require 3-state control input G to be set low to place the output into the high impedance.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

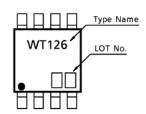


Weight: 0.02g (Typ.)

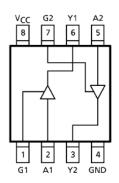
#### **FEATURES**

- High Speed ...... t<sub>pd</sub> = 13ns (Typ.) at V<sub>CC</sub> = 5V
- Low Power Dissipation ········· I<sub>CC</sub> = 2μA (Max.) at Ta = 25°C
- Compatible with TTL outputs ··· V<sub>IL</sub> = 0.8V (Max.), V<sub>IH</sub> = 2.0V (Min.)
- Output Drive Capability ...... 15 LSTTL Loads
- Symmetrical Output Impedance… |IOH| = IOL = 6mA (Min.)

#### MARKING



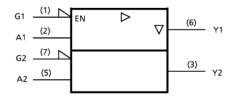
# PIN ASSIGNMENT (TOP VIEW)



#### MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage Range	Vcc	-0.5~7	V
DC Input Voltage	VIN	-0.5~V <sub>CC</sub> +0.5	٧
DC Output Voltage	Vout	-0.5~V <sub>CC</sub> +0.5	٧
Input Diode Current	ΙK	± 20	mA
Output Diode Current	lok	± 20	mA
DC Output Current	IOUT	± 35	mA
DC V <sub>CC</sub> /Ground Current	lcc	± 37.5	mA
Power Dissipation	PD	300	mW
Storage Temperature	T <sub>stg</sub>	-65~150	°C
Lead Temperature (10 s)	TL	260	°C

## LOGIC DIAGRAM



### TRUTH TABLE

INP	UTS	OUTPUTS			
G	Α	Y			
L	×	Z			
Н	L	L			
Н	Н	Н			

x : Don't Care Z : High Impedance

### RECOMMENDED OPERATING CONDITIONS

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage	Vcc	4.5~5.5	V
Input Voltage	VIN	0~V <sub>CC</sub>	V
Output Voltage	Vout	0~V <sub>CC</sub>	V
Operating Temperature	T <sub>opr</sub>	<i>-</i> 40∼85	°C
Input Rise and Fall Time	t <sub>r</sub> , t <sub>f</sub>	0~500	ns

### DC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC SYMBO		TEST CONDITION		Vcc	Ta = 25°C			Ta = −40~85°C		UNIT
CHARACTERISTIC	CHARACTERISTIC STRIBUTE		Vcc (V)	MIN.	TYP.	MAX.	MIN.	MAX.	CIVIT	
High-Level	VIH			4.5~	2.0	_	_	2.0	_	V
Input Voltage				5.5						
Low-Level	<sub>VIL</sub>			4.5~		_	0.8	l _	0.8	l v l
Input Voltage	" L			5.5	-	_	0.0	-	0.6	ľ
High-Level	VOH	V <sub>IN</sub> = V <sub>IH</sub>	$I_{OH} = -20\mu A$	4.5	4.4	4.5	_	4.4	_	V
Output Voltage	VOH	VIN = VIH	$I_{OH} = -6mA$	4.5	4.18	4.31	_	4.13	_	ľ
Low-Level	V	$V_{IN} = V_{IH}$	$I_{OL} = 20 \mu A$	4.5	_	0.0	0.10	_	0.10	v
Output Voltage	VOL	or V <sub>IL</sub>	$I_{OL} = 6mA$	4.5	_	0.17	0.26	_	0.33	_
3-State Output	lon	VIN = = VIH or VIL		5.5		_   _	± 0.5	_	± 5.0	μΑ
Off-State Current	loz	V <sub>OUT</sub> = V <sub>CC</sub>	3.3							
Input Leakage	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5			± 0.1		± 1.0	μΑ
Current	אוי ן	1 A IM - ACC 0	I GIVD	] 3.5		_   _	5.1		≟ 1.0	μΑ
	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	2.0	-	20.0	$\mu$ A
Quiescent Supply		PER INPUT	$: V_{IN} = 0.5V$							
Current	Iсст		or 2.4V	5.5	l —	<b>—</b>	2.0	—	2.9	mΑ
		OTHER INPUT: V <sub>CC</sub> or GND								

## AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 6ns$ )

CHARACTERISTIC	SYMBOL	TEST CONDI		N	Ta = 25°C		Ta = −40~85°C			
	STIVIBOL		CL	Vcc	MIN.	TYP.	MAX.	MIN.	MAX.	UNIT
Output Transition	tTLH			4.5	_	7	12	_	15	ns
Time	tTHL	_	50	5.5	_	6	11	_	14	
		_	50	4.5	_	15	25	_	31	
Propagation Delay	tpLH			5.5	_	13	22	_	28	ns
Time	tpHL		150	4.5	_	21	33	_	41	
	'			5.5	_	18	29	_	37	
Output Enable Time	tpZL	$R_L = 1k\Omega$	50 150	4.5	_	17	30	_	38	ns
				5.5	_	14	27	_	34	
	<sup>t</sup> pZL <sup>t</sup> pZH			4.5	_	23	38	_	48	
	'			5.5	_	20	34	_	43	
Outnot Disable Time	tpLZ	$R_L = 1k\Omega$	50	4.5	_	16	30	_	38	
Output Disable Time	tpHZ			5.5	_	13	27	_	34	ns
Input Capacitance	CIN	_	_	_	_	5	10	_	10	pF
Output Capacitance	COUT	_	_	_	_	10	_	<u> </u>	<u> </u>	pF
Power Dissipation						22				
Capacitance	C <sub>PD</sub>	(Note 1)				32				pF

(Note 1): CpD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

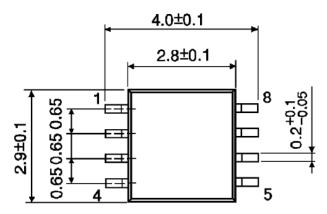
Average operating current can be obtained by the equation:

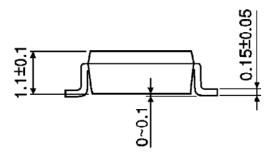
ICC (opr) = CpD · VCC · fIN + ICC / 2 (per Gate)

3 2008-06-03

### PACKAGE DIMENSIONS

SSOP8-P-0.65 Unit: mm





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Weight: 0.02g (Typ.)

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